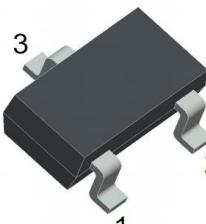
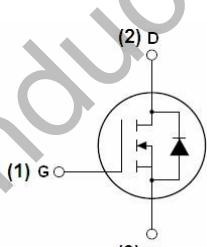


 <b>WG2310</b> 60V N-Channel MOSFET	 <b>SOT-23</b>  <b>1.GATE 2.SOURCE 3.DRAIN</b>  Marking:MS10
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### Maximum ratings ( Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	VGS	$\pm 20$	
Continuous Drain Current	ID	3	A
Pulsed Diode Current	IDM	10	
Continuous Source-Drain Current(Diode Conduction)	IS	0.8	
Power Dissipation	PD	1.25	W
Thermal Resistance from Junction to Ambient (t≤5s)	R <sub>θJA</sub>	357	°C/W
Operating Junction	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55~+150	°C

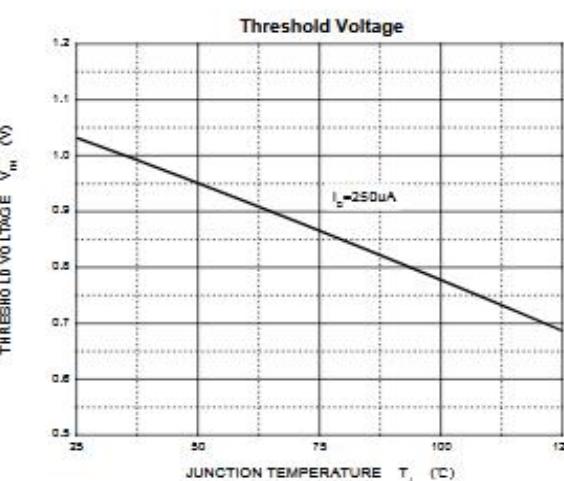
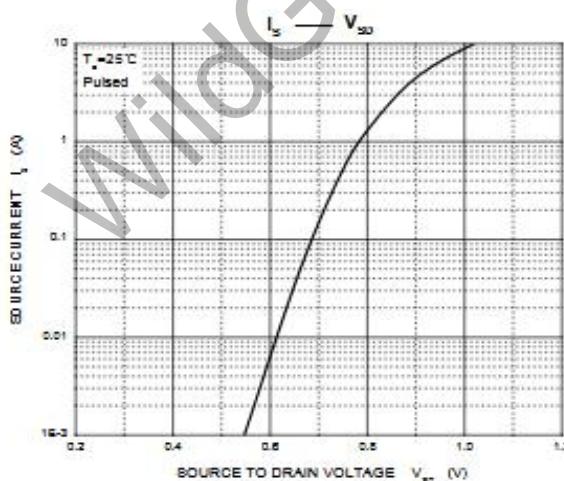
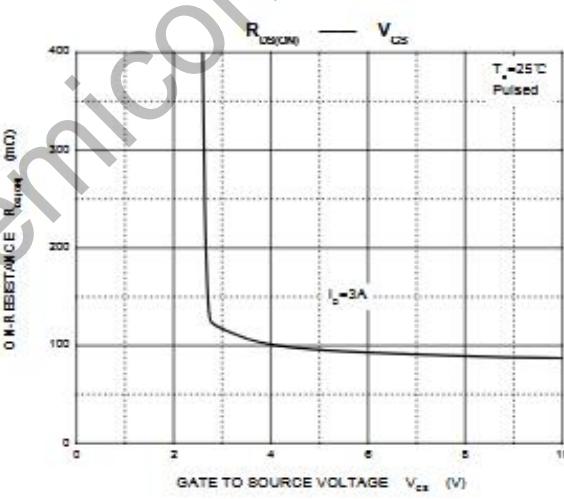
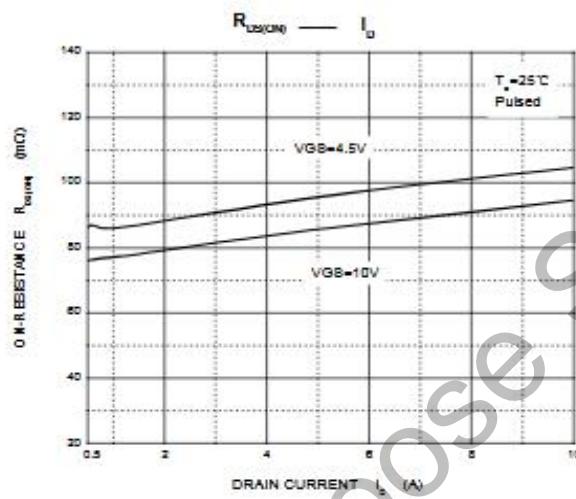
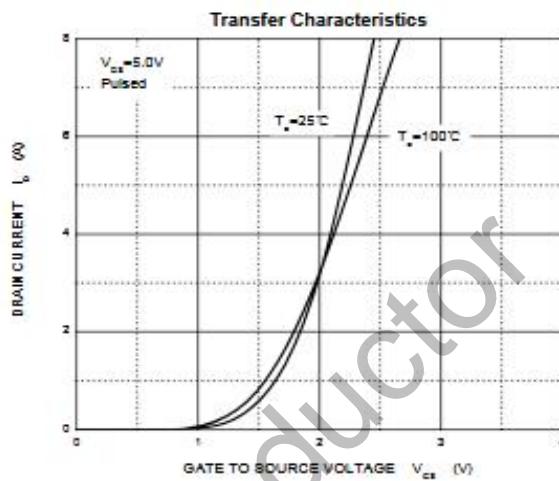
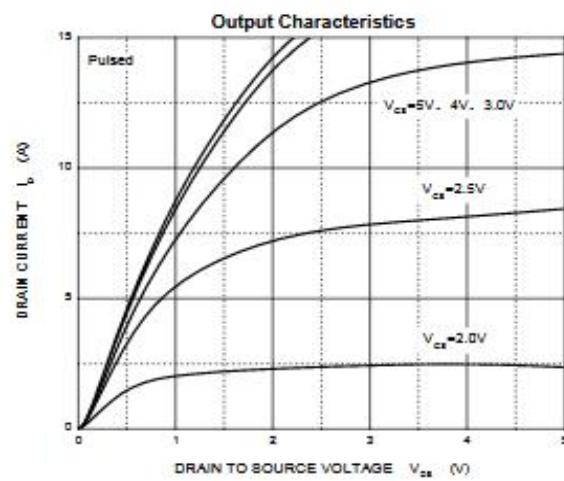
**Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250µA	60			V
Gate-source threshold voltage	VGS(th)	VDS = VGS, ID = 250µA	0.9		2	V
Gate-source leakage	IGSS	VDS = 0V, VGS = ±20V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 60V, VGS = 0V			1	µA
Drain-source on-state resistancea	RDS(on)	VGS = 10V, ID = 3 A		72	95	mΩ
		VGS = 4.5V, ID = 2 A		82	100	mΩ
Forward transconductancea	gfs	VDS = 4.5V, ID = 3A		7		S
Diode forward voltage	VSD	IS=1A,VGS=0V		0.8	1.2	V
<b>Dynamic</b>						
Input capacitance	Ciss	VDS = 10V,VGS =0V, f=1MHz		247		pF
Output capacitance	Coss			34		pF
Reverse transfer capacitanceb	Crss			20		pF
Total gate charge	Qg	VDS = 10V,VGS = 4.5V, ID = 3A		6	4.5	nC
Gate-source charge	Qgs			1		nC
Gate-drain charge	Qgd			1.3		nC
Gate resistance	Rg	f=1MHz		5		Ω
<b>Switchingb</b>						
Turn-on delay time	td(on)	VDD= 10V RL=10Ω, ID ≈ 1A, VGEN= 4.5V,Rg=6Ω		7	15	ns
Rise time	tr			15	20	ns
Turn-off delay time	td(off)			15	25	ns
Fall time	tf			10	20	ns
<b>Drain-source body diode characteristics</b>						
Continuous Source-Drain Diode Current	IS	Tc=25 °C			1.2	A
Pulsed Diode forward Current	ISM				20	A

**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t < 5 sec.
3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.

## Typical Characteristics



Package Dimension

SOT-23

Unit: mm

